

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Tao Feng	07/22/2009
RECEIVING PARTY DATA	
Name:	ALPHA & OMEGA SEMICONDUCTOR INCORPORATED
Street Address:	495 Mercury Drive
City:	Sunnyvale
State/Country:	CALIFORNIA
Postal Code:	94085
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12507778
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	ANO-024/US
NAME OF SUBMITTER:	JOSHUA D. ISENBERG
Total Attachments: 1 source=ANO-024US_assignment#page1.tif	

OP \$40.00 12507778

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PATENT
REEL: 022993 FRAME: 0516

ASSIGNMENT

**INVENTOR
AND CITY**

Whereas, I, **Tao Feng** of 900 Pepper Tree Ln # 1022
Santa Clara, CA 95051

have invented:

TITLE:

**CHIP SCALE SURFACE MOUNTED SEMICONDUCTOR DEVICE
PACKAGE AND PROCESS OF MANUFACTURE**

DATE INVENTOR and executed a United States patent application therefor
SIGNED THE
DECLARATION

on July 22, 2009. Said assignor hereby authorize and request
their attorney, Joshua D. Isenberg, of 809 Corporate Way, Fremont,
California, to insert here in parentheses (Application number
12/507,778, filed July 22, 2009) the filing
date and application number of said application when known.

Whereas, **Alpha & Omega Semiconductor Incorporated**, a
California Corporation, having its registered address at 495 Mercury
Drive, Sunnyvale, CA 94085, (hereinafter called AOS), desires to acquire
the entire right, title and interest of said application and invention, and to
any United States and foreign patents to be obtained therefore;

Now therefore for a valuable consideration, receipt whereof is
hereby acknowledged, I, the above named, hereby sell, assign, and transfer
to AOS, its successors and assigns, the entire right, title and interest in the
said application and invention therein disclosed for the United States and
foreign countries, and all rights of priority resulting from the filing said
United States application, and I request the Commissioner of Patents to
issue any Letters Patent granted upon the invention set forth in said
application to AOS its successors and assigns; and I hereby agree that
AOS may apply for foreign Letters Patent on said invention and I will
execute all papers necessary in connection with the United States and
foreign applications when called upon to do so by

CITY AND

Signed and Sealed at Sunnyvale, CA

DATE

on July 22, 2009


SIGNATURE OF INVENTOR